

Strategic Wireless Applications
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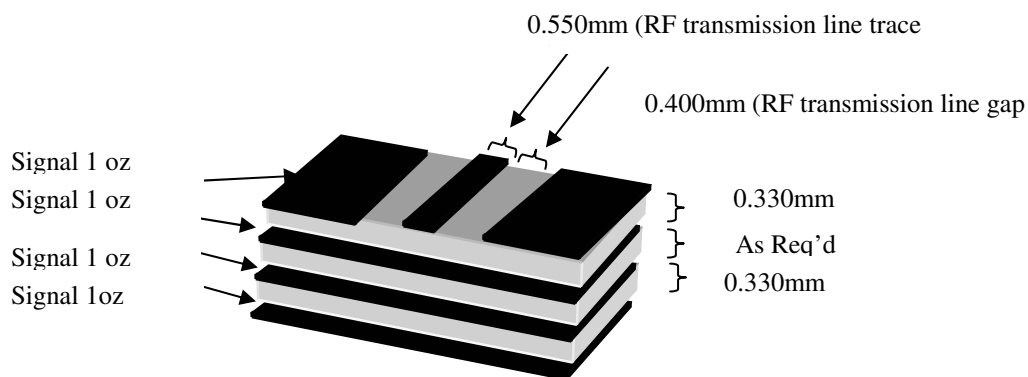
PCB Project/Physical Description

EV Kit Part Number MAX2741 EVKIT Rev. 2

Quantity : Quote for 20 pcs Turn (working days) : 10 day

Layers: 4 PCB Thickness: 1.575mm Dielectric: High Tg FR-4 (or equivalent) RoHS compliant material ONLY

RF characteristic impedance: 50Ω Dielectric Constant: 4.5



Min. drill size(finish): 0.254mm ☐ Blind(from layer, to layer): N/A Min. line width/spacing: 0.160mm / 0.160mm

Plating: ✓ 3-8u" Immersion Au over 180u" Ni

Board dimensions: 76.20mm X 76.20mm # of surface mount pads (top) 332 # of surface mount pads (bottom) 0

Approx. # of holes: 381 Silkscreen: White, Soldermask: Green, Both Sides

Scoring (location): . Additional features: .

Tolerance

Board Dimensions: 0.254mm
 Plated Thru Holes: 0.076mm
 Pattern to Pattern: 0.127mm
 Soldermask to Pattern: 0.127mm
 Legend to Legend: 0.178mm